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**COVER SHEET
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Record the attached documents or the new address(es) below.

1. Name of conveying party(ies):
Jun Hitonishi (02/07/2008) and Akira Aochi
(02/07/2008)

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: Funai Electric Co., Ltd.
Internal Address: _____
Street Address: _____

3. Nature of conveyance/Execution Date(s):

Execution Date(s): In parentheses after inventor name _____
 Assignment Merger Change of Name
 Security Agreement Joint Research Agreement
 Government Interest Assignment
 Executive Order 9424, Confirmatory License
 Other _____

7-7-1, Nakagaito, Daito-shi
Osaka 574-0013 JAPAN

City: _____
State: _____
Country: _____ Zip: _____
Additional name(s) & address(es) attached? Yes No

4. Application or patent number(s): This document is being filed together with a new application.
A. Patent Application No.(s) _____
B. Patent No.(s) _____

Additional numbers attached? Yes No

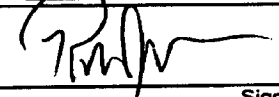
6. Total number of applications and patents involved: 1

5. Name and address to whom correspondence concerning document should be mailed:

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7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
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 None required (government interest not affecting title)

9. Signature:  _____
Signature Date February 13, 2008

Robert J. Goodell - 41,040 _____
Name of Person Signing Total number of pages including cover sheet, attachments, and documents: 2

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

DIGITAL BROADCASTING RECEIVING APPARATUS

for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on _____, (Application No. _____); and

WHEREAS, FUNAI ELECTRIC CO., LTD., a corporation of Japan, whose post office address is 7-7-1, Nakagaito, Daito-shi, Osaka 574-0013 Japan, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. _____, filed February 13, 2008) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

Full Name of First Assignor Jun HITONISHI	Assignor's Signature <i>Jun Hitonishi</i>	Date <i>Feb. 7. 2008</i>
Address C/O FUNAI ELECTRIC CO., LTD., 7-7-1, Nakagaito, Daito-shi, Osaka 574-0013 Japan		Citizenship Japan
Full Name of Second Assignor Akira AOCHI	Assignor's Signature <i>Akira Aochi</i>	Date <i>Feb. 7. 2008</i>
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